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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re the Application of	Gerard Chauvel, et al.	TI-35422	Art Unit: 2186
Serial No.:	10/632,228	Examiner: Mano Padmanabhan	
Filed:	July 31, 2003	Conf. No.: 2073	
For:	System and Method to Automatically Stack and Unstack Java Local Variables		

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NAME OF INVENTOR(S): Gerard Chauvel, et al.	RECEIPT DATE & SERIAL NO.: **Serial No.: 10/632,228** **Filing Date:** July 31, 2003
TITLE OF INVENTION: System and Method to Automatically Stack and Unstack Java Local Variables	
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